



# Film Capacitors

## Metallized Polypropylene Film Capacitors (MKP)

**Series/Type: B32669**

The following products presented in this data sheet are being withdrawn.

| Ordering Code      | Substitute Product | Date of Withdrawal | Deadline Last Orders | Last Shipments |
|--------------------|--------------------|--------------------|----------------------|----------------|
| see following page |                    | 2014-04-11         | 2014-07-15           | 2014-10-15     |

For further information please contact your nearest EPCOS sales office, which will also support you in selecting a suitable substitute. The addresses of our worldwide sales network are presented at [www.epcos.com/sales](http://www.epcos.com/sales).

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## Affected products (Ordering code)

|                         |                 |
|-------------------------|-----------------|
| <b>B32669</b> B6105J000 | B32669S3225K500 |
| B32669B6105K000         | B32669S3405K506 |
| B32669B6155J000         | B32669S3505K550 |
| B32669B6155K000         | B32669S3564K600 |
| B32669B6205K000         | B32669S3605K500 |
| B32669B6255K000         | B32669S3684K500 |
| B32669B6305J150         | B32669S3684K600 |
| B32669B6305K000         |                 |
| B32669B6405K000         |                 |
| B32669B6505K000         |                 |
| B32669B6605K000         |                 |
| B32669C1156K000         |                 |
| B32669C3106J000         |                 |
| B32669C3205J000         |                 |
| B32669C3205K000         |                 |
| B32669C3225K000         |                 |
| B32669C3255J000         |                 |
| B32669C3255K000         |                 |
| B32669C3305K000         |                 |
| B32669C3405K000         |                 |
| B32669C3605K000         |                 |
| B32669C3805K000         |                 |
| B32669S1104K500         |                 |
| B32669S3105K500         |                 |
| B32669S3105K501         |                 |
| B32669S3106K500         |                 |
| B32669S3126K550         |                 |
| B32669S3156K550         |                 |

**Not suitable for "across the line" applications!**

**Typical applications**

- Energy storage
- Filtering

**Climatic**

- Max. operating temperature: 85 °C
- Climatic category (IEC 60068-1): 40/085/21

**Construction**

- Dielectric: polypropylene (PP)
- Cylindrical winding
- Insulating sleeve
- Face ends sealed with epoxy resin

**Features**

- Good self-healing properties
- RoHS-compatible

**Terminals**

- Axial leads, lead-free tinned
- Axial leads, insulated, tinned copper wires gathered together by a tin cover (fray), AWG 22

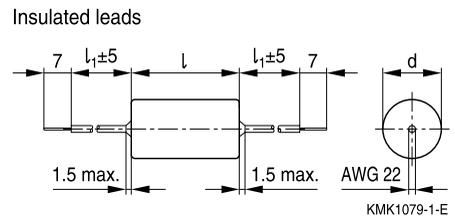
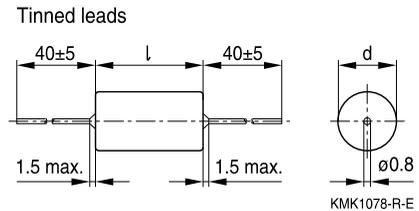
**Marking**

Manufacturer  
 Series number  
 rated capacitance (coded),  
 capacitance tolerance (code letter),  
 rated AC voltage, frequency, date code

**Delivery mode**

Bulk (untaped)

**Dimensional drawing**



Dimensions in mm

When bending leads, take care to leave a clearance of 1 mm to the capacitor body.



**Overview of available types**

| Version                 | Tinned leads |     | Insulated leads |     |
|-------------------------|--------------|-----|-----------------|-----|
| Page                    | 4            |     | 5               |     |
| V <sub>RMS</sub> (V AC) | 250          | 400 | 250             | 400 |
| C <sub>R</sub> (μF)     |              |     |                 |     |
| 1.0                     |              |     |                 |     |
| 1.5                     |              |     |                 |     |
| 2.0                     |              |     |                 |     |
| 2.5                     |              |     |                 |     |
| 3.0                     |              |     |                 |     |
| 4.0                     |              |     |                 |     |
| 5.0                     |              |     |                 |     |
| 6.0                     |              |     |                 |     |
| 8.0                     |              |     |                 |     |
| 10                      |              |     |                 |     |



**B32669**

**AC applications (wound)**

**Ordering codes and packing units (tinned leads)**

| $V_{RMS}$ | $C_R$   | Max. dimensions<br>$d \times l$<br>mm | Ordering code<br>(composition see<br>below) | Untaped<br>pcs./MOQ |
|-----------|---------|---------------------------------------|---|---------------------|
| V AC      | $\mu F$ |                                       |   |                     |
| 250       | 1.0     | 9.0 × 32.0                            | B32669C3105+000                             | 1000                |
|           | 1.5     | 11.0 × 32.0                           | B32669C3155+000                             | 1000                |
|           | 2.0     | 12.5 × 32.0                           | B32669C3205+000                             | 800                 |
|           | 2.5     | 14.0 × 32.0                           | B32669C3255+000                             | 800                 |
|           | 3.0     | 15.5 × 32.0                           | B32669C3305+000                             | 600                 |
|           | 4.0     | 15.0 × 47.0                           | B32669C3405+000                             | 600                 |
|           | 6.0     | 17.0 × 47.0                           | B32669C3605+000                             | 400                 |
|           | 8.0     | 19.5 × 47.0                           | B32669C3805+000                             | 200                 |
|           | 10      | 21.5 × 47.0                           | B32669C3106+000                             | 200                 |
| 400       | 1.0     | 13.0 × 32.0                           | B32669B6105+000                             | 1000                |
|           | 1.5     | 15.0 × 32.0                           | B32669B6155+000                             | 800                 |
|           | 2.0     | 19.0 × 32.0                           | B32669B6205+000                             | 800                 |
|           | 2.5     | 21.0 × 32.0                           | B32669B6255+000                             | 600                 |
|           | 3.0     | 18.0 × 47.0                           | B32669B6305+000                             | 600                 |
|           | 4.0     | 21.0 × 47.0                           | B32669B6405+000                             | 400                 |
|           | 5.0     | 22.0 × 47.0                           | B32669B6505+000                             | 600                 |
|           | 6.0     | 25.5 × 47.0                           | B32669B6605+000                             | 200                 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.  
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%


**Ordering codes and packing units (insulated leads)**

| $V_{RMS}$ | $C_R$   | Max. dimensions<br>$d \times l$<br>mm | Ordering code<br>(composition see<br>below) | Untaped<br>pcs./MOQ |
|-----------|---------|---------------------------------------|---|---------------------|
| V AC      | $\mu F$ |                                       |   |                     |
| 250       | 1.0     | 9.0 × 32.0                            | B32669S3105+***                             | 1000                |
|           | 1.5     | 11.0 × 32.0                           | B32669S3155+***                             | 1000                |
|           | 2.0     | 12.5 × 32.0                           | B32669S3205+***                             | 1000                |
|           | 2.5     | 14.0 × 32.0                           | B32669S3255+***                             | 1000                |
|           | 3.0     | 15.5 × 32.0                           | B32669S3305+***                             | 800                 |
|           | 4.0     | 15.0 × 47.0                           | B32669S3405+***                             | 800                 |
|           | 6.0     | 17.0 × 47.0                           | B32669S3605+***                             | 600                 |
|           | 8.0     | 19.5 × 47.0                           | B32669S3805+***                             | 600                 |
|           | 10      | 21.5 × 47.0                           | B32669S3106+***                             | 600                 |
| 400       | 1.0     | 13.0 × 32.0                           | B32669S6105+***                             | 1000                |
|           | 1.5     | 15.0 × 32.0                           | B32669S6155+***                             | 1000                |
|           | 2.0     | 19.0 × 32.0                           | B32669S6205+***                             | 1000                |
|           | 2.5     | 21.0 × 32.0                           | B32669S6255+***                             | 600                 |
|           | 3.0     | 18.0 × 47.0                           | B32669S6305+***                             | 600                 |
|           | 4.0     | 21.0 × 47.0                           | B32669S6405+***                             | 600                 |
|           | 5.0     | 22.0 × 47.0                           | B32669S6505+***                             | 600                 |
|           | 6.0     | 25.5 × 47.0                           | B32669S6605+***                             | 600                 |

MOQ = Minimum Order Quantity, consisting of 4 packing units.  
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K =  $\pm 10\%$

J =  $\pm 5\%$

\*\*\* = Code number for lead version and length:

504 = Insulated leads (lead length 160 mm)

508 = Insulated leads (lead length 65 mm)





## Mounting guidelines

### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

|   |   |
|---|---|
| Solder bath temperature                   | 235 ±5 °C   |
| Soldering time                            | 2.0 ±0.5 s  |
| Immersion depth                           | 2.0 +0/−0.5 mm from capacitor body or seating plane             |
| Evaluation criteria:<br>Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |

#### 1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

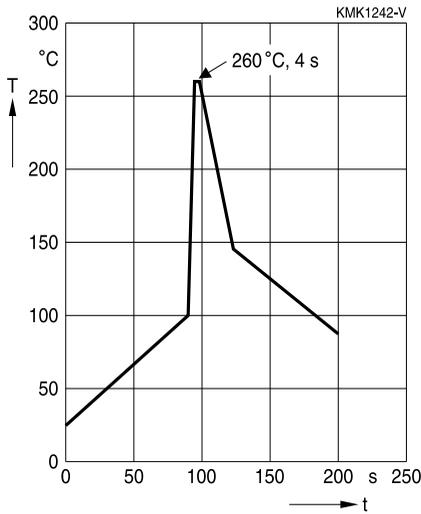
Conditions:

| Series   | Solder bath temperature | Soldering time   |
|--|-------------------------|--|
| MKT boxed (except 2.5 × 6.5 × 7.2 mm)<br>coated<br>uncoated (lead spacing > 10 mm)       | 260 ±5 °C               | 10 ±1 s  |
| MFP<br>MKP (lead spacing > 7.5 mm)   |                         |  |
| MKT boxed (case 2.5 × 6.5 × 7.2 mm)  |                         | 5 ±1 s   |
| MKP (lead spacing ≤ 7.5 mm)<br>MKT uncoated (lead spacing ≤ 10 mm)<br>insulated (B32559) |                         | < 4 s<br>recommended soldering<br>profile for MKT uncoated<br>(lead spacing ≤ 10 mm) and<br>insulated (B32559) |



**B32669**

**AC applications (wound)**



|                      |   |
|----------------------|---|
| Immersion depth      | 2.0 +0/−0.5 mm from capacitor body or seating plane                                 |
| Shield               | Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder |
| Evaluation criteria: |   |
| Visual inspection    | No visible damage   |
| $\Delta C/C_0$       | 2% for MKT/MKP/MFP<br>5% for EMI suppression capacitors                             |
| $\tan \delta$        | As specified in sectional specification   |



### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### Uncoated capacitors

For uncoated MKT capacitors with lead spacings  $\leq 10$  mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



**B32669**

**AC applications (wound)**

### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic                   | Safety information  | Reference chapter<br>"General technical<br>information" |
|-------------------------|---|---|
| Storage conditions      | Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.   | 4.5<br>"Storage conditions"                             |
| Flammability            | Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.   | 5.3<br>"Flammability"                                   |
| Resistance to vibration | Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6.<br>EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics". | 5.2<br>"Resistance to vibration"                        |



| Topic  | Safety information  | Reference chapter<br>"Mounting guidelines"         |
|--|---|--|
| Soldering                                      | Do not exceed the specified time or temperature limits during soldering.  | 1 "Soldering"                                      |
| Cleaning                                       | Use only suitable solvents for cleaning capacitors.   | 2 "Cleaning"                                       |
| Embedding of capacitors in finished assemblies | When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account.<br>Caution: Consult us first, if you also wish to embed other uncoated component types! | 3 "Embedding of capacitors in finished assemblies" |



B32669

AC applications (wound)

## Symbols and terms

| Symbol               | English   | German  |
|----------------------|---|---|
| $\alpha$             | Heat transfer coefficient   | Wärmeübergangszahl  |
| $\alpha_C$           | Temperature coefficient of capacitance                                    | Temperaturkoeffizient der Kapazität   |
| A                    | Capacitor surface area  | Kondensatoroberfläche   |
| $\beta_C$            | Humidity coefficient of capacitance                                       | Feuchtekoeffizient der Kapazität  |
| C                    | Capacitance   | Kapazität   |
| $C_R$                | Rated capacitance   | Nennkapazität   |
| $\Delta C$           | Absolute capacitance change   | Absolute Kapazitätsänderung   |
| $\Delta C/C$         | Relative capacitance change (relative deviation of actual value)          | Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)                  |
| $\Delta C/C_R$       | Capacitance tolerance (relative deviation from rated capacitance)         | Kapazitätstoleranz (relative Abweichung vom Nennwert)                           |
| dt                   | Time differential   | Differentielle Zeit   |
| $\Delta t$           | Time interval   | Zeitintervall   |
| $\Delta T$           | Absolute temperature change (self-heating)                                | Absolute Temperaturänderung (Selbsterwärmung)                                   |
| $\Delta \tan \delta$ | Absolute change of dissipation factor                                     | Absolute Änderung des Verlustfaktors  |
| $\Delta V$           | Absolute voltage change   | Absolute Spannungsänderung  |
| dV/dt                | Time differential of voltage function (rate of voltage rise)              | Differentielle Spannungsänderung (Spannungsflankensteilheit)                    |
| $\Delta V/\Delta t$  | Voltage change per time interval  | Spannungsänderung pro Zeitintervall   |
| E                    | Activation energy for diffusion   | Aktivierungsenergie zur Diffusion   |
| ESL                  | Self-inductance   | Eigeninduktivität   |
| ESR                  | Equivalent series resistance  | Ersatz-Serienwiderstand   |
| f                    | Frequency   | Frequenz  |
| $f_1$                | Frequency limit for reducing permissible AC voltage due to thermal limits | Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung |
| $f_2$                | Frequency limit for reducing permissible AC voltage due to current limit  | Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung      |
| $f_r$                | Resonant frequency  | Resonanzfrequenz  |
| $F_D$                | Thermal acceleration factor for diffusion                                 | Therm. Beschleunigungsfaktor zur Diffusion                                      |
| $F_T$                | Derating factor   | Deratingfaktor  |
| i                    | Current (peak)  | Stromspitze   |
| $I_C$                | Category current (max. continuous current)                                | Kategoriestrom (max. Dauerstrom)  |



| Symbol           | English  | German  |
|------------------|--|---|
| $I_{RMS}$        | (Sinusoidal) alternating current, root-mean-square value | (Sinusförmiger) Wechselstrom                      |
| $i_z$            | Capacitance drift  | Inkonstanz der Kapazität                          |
| $k_0$            | Pulse characteristic                                     | Impuls Kennwert                                   |
| $L_S$            | Series inductance  | Serieninduktivität                                |
| $\lambda$        | Failure rate   | Ausfallrate                                       |
| $\lambda_0$      | Constant failure rate during useful service life         | Konstante Ausfallrate in der Nutzungsphase        |
| $\lambda_{test}$ | Failure rate, determined by tests                        | Experimentell ermittelte Ausfallrate              |
| $P_{diss}$       | Dissipated power   | Abgegebene Verlustleistung                        |
| $P_{gen}$        | Generated power  | Erzeugte Verlustleistung                          |
| $Q$              | Heat energy  | Wärmeenergie                                      |
| $\rho$           | Density of water vapor in air                            | Dichte von Wasserdampf in Luft                    |
| $R$              | Universal molar constant for gases                       | Allg. Molarkonstante für Gas                      |
| $R$              | Ohmic resistance of discharge circuit                    | Ohmscher Widerstand des Entladekreises            |
| $R_i$            | Internal resistance                                      | Innenwiderstand                                   |
| $R_{ins}$        | Insulation resistance                                    | Isolationswiderstand                              |
| $R_P$            | Parallel resistance                                      | Parallelwiderstand                                |
| $R_S$            | Series resistance  | Serienwiderstand                                  |
| $S$              | severity (humidity test)                                 | Schärfegrad (Feuchtest)                           |
| $t$              | Time   | Zeit  |
| $T$              | Temperature  | Temperatur  |
| $\tau$           | Time constant  | Zeitkonstante                                     |
| $\tan \delta$    | Dissipation factor                                       | Verlustfaktor                                     |
| $\tan \delta_D$  | Dielectric component of dissipation factor               | Dielektrischer Anteil des Verlustfaktors          |
| $\tan \delta_P$  | Parallel component of dissipation factor                 | Parallelanteil des Verlustfaktors                 |
| $\tan \delta_S$  | Series component of dissipation factor                   | Serienanteil des Verlustfaktors                   |
| $T_A$            | Ambient temperature                                      | Umgebungstemperatur                               |
| $T_{max}$        | Upper category temperature                               | Obere Kategorietemperatur                         |
| $T_{min}$        | Lower category temperature                               | Untere Kategorietemperatur                        |
| $t_{OL}$         | Operating life at operating temperature and voltage      | Betriebszeit bei Betriebstemperatur und -spannung |
| $T_{op}$         | Operating temperature                                    | Betriebstemperatur                                |
| $T_R$            | Rated temperature  | Nenntemperatur                                    |
| $T_{ref}$        | Reference temperature                                    | Referenztemperatur                                |
| $t_{SL}$         | Reference service life                                   | Referenz-Lebensdauer                              |
| $V_{AC}$         | AC voltage   | Wechselspannung                                   |


**B32669**
**AC applications (wound)**

| Symbol      | English   | German                                      |
|-------------|---|---|
| $V_C$       | Category voltage  | Kategoriespannung                           |
| $V_{C,RMS}$ | Category AC voltage   | (Sinusförmige)<br>Kategorie-Wechselspannung |
| $V_{CD}$    | Corona-discharge onset voltage                              | Teilentlade-Einsatzspannung                 |
| $V_{ch}$    | Charging voltage  | Ladespannung                                |
| $V_{DC}$    | DC voltage  | Gleichspannung                              |
| $V_{FB}$    | Fly-back capacitor voltage                                  | Spannung (Flyback)                          |
| $V_i$       | Input voltage   | Eingangsspannung                            |
| $V_o$       | Output voltage  | Ausgangssspannung                           |
| $V_{op}$    | Operating voltage   | Betriebssspannung                           |
| $V_p$       | Peak pulse voltage  | Impuls-Spitzenspannung                      |
| $V_{pp}$    | Peak-to-peak voltage Impedance                              | Spannungshub                                |
| $V_R$       | Rated voltage   | Nennspannung                                |
| $\hat{V}_R$ | Amplitude of rated AC voltage                               | Amplitude der Nenn-Wechselspannung          |
| $V_{RMS}$   | (Sinusoidal) alternating voltage,<br>root-mean-square value | (Sinusförmige) Wechselspannung              |
| $V_{SC}$    | S-correction voltage  | Spannung bei Anwendung "S-correction"       |
| $V_{sn}$    | Snubber capacitor voltage                                   | Spannung bei Anwendung<br>"Beschaltung"     |
| $Z$         | Impedance   | Scheinwiderstand                            |
| $e$         | Lead spacing  | Rastermaß                                   |

## Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
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